PHN 17,093



5	Form PTO 1595 (Rev. 6-93) 1011833	U.S. Dept. of Commerce Patent and Trademark Office
<u>.</u>	To the Honorable Commissioner of Patents and Trademarks: Please record the attached original docopy thereof.	
0 10-2	 Name of conveying party(ies): MARIAN N. WEBSTER Additional name(s) of conveying party(ies) attack 	2. Name and address of receiving party(ies): Name: U.S. PHILIPS CORPORATION Internal Address:
Σ	Yes X 3. Nature of conveyance: X Assignment Merger Security Agreement Change of T Other Execution Date: SEPTEMBER 29, 1999	Xual trong triallets) at address (es) attached:
	isA. Patert Application No.(s)	a new application, the execution date of the application, B. Patent No.(s) dditional numbers attached? Yesx No
	5. Name and address of party to whom corresponde concerning document should be mailed:	6. Total number of applications and patents involved:
	Name: U.S. PHILIPS CORPORATION Internal Address: Street Address: _580 White Plains Road	_ Enclosed X Authorized to Deposit Account
	City: <u>Tarrytown</u> State: <u>NY</u> Zip: <u>10591</u>	8. Deposit Account Number: 14-1270 (Attach duplicate copy of this page paying by deposit account)
	DO NOT USE THIS SPACE	
9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any accopy is a true copy of the original document.		
	Steven R. Biren, Reg.No. 26,531 Name of Person Signing Total number of pages including o	Signature Date sover sheet, attachments, and document: 2

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1999-09-29

Date

For good and valuable consideration, of which I acknowledge receipt, I, as a below-named assignor, sell and assign to U.S. Philips Corporation (hereinafter "Assignee") a corporation existing under the laws of the State of Delaware, whose business address is 1251 Avenue of the Americas, New York, NY 10020-1104, its successors and assigns, the application for a United States Patent for the improvements in a "Method of manufacturing a semiconductor device comprising a semiconductor body having a surface provided with a coil having a magnetic core" invented by me, which application:

is executed concurrently herewith
was executed by me/us on
☑ is Serial No09/397742 filed .September 16th, 1999
is International Application No
and all rights in and to said application, and all Patents which may be granted therefor, and all divisions,
reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents and
Trademarks to issue all Patents on said improvements or resulting therefrom to said Assignee as assignee
of the entire interest and covenant that I have full right so to do, and agree that I will communicate to said
Assignee or its representatives any facts known to me respecting said improvements and testify in any
legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make
all rightful oaths and generally do everything possible to aid said Assignee, its successors, assigns and
nominees, to obtain and enforce proper protection for said invention.
a a
y

PATENT REEL: 010328 FRAME: 0354

, Assignor

(sign name here)

(print name here)